



Edition 1.0 2021-10

INTERNATIONAL STANDARD



Printed electronics – Part 201-2: Materials – Substrates – Measurement methods for properties of stretchable substrates

INTERNATIONAL ELECTROTECHNICAL COMMISSION

ICS 29.035.01; 31.180

ISBN 978-2-8322-5434-9

Warning! Make sure that you obtained this publication from an authorized distributor.

CONTENTS

FOREWORD	3
INTRODUCTION	5
1 Scope	6
2 Normative references	6
3 Terms and definitions	6
4 Structures and materials	7
4.1 Structures	7
4.2 Materials	7
5 General description of measurement tests	8
6 Characteristics and measurement methods of stretchable substrates	8
6.1 Width and length of stretchable substrates	8
6.2 Thickness of stretchable substrates	
6.3 Mass per unit area of stretchable fabrics	
6.4 Elongation at break of stretchable fabrics	
6.5 Volume resistance of stretchable polymer films and sheets	
6.6 Surface resistance of stretchable polymer films and sheets	9
6.7 Electric strength of stretchable polymer films and sheets	
7 Storage	9
8 Packing and marking	9
9 Shipment	9
Bibliography	. 10
Table 1 – Types and schematic cross section of stretchable substrates	8

INTERNATIONAL ELECTROTECHNICAL COMMISSION

PRINTED ELECTRONICS -

Part 201-2: Materials – Substrates – Measurement methods for properties of stretchable substrates

FOREWORD

- 1) The International Electrotechnical Commission (IEC) is a worldwide organization for standardization comprising all national electrotechnical committees (IEC National Committees). The object of IEC is to promote international co-operation on all questions concerning standardization in the electrical and electronic fields. To this end and in addition to other activities, IEC publishes International Standards, Technical Specifications, Technical Reports, Publicly Available Specifications (PAS) and Guides (hereafter referred to as "IEC Publication(s)"). Their preparation is entrusted to technical committees; any IEC National Committee interested in the subject dealt with may participate in this preparatory work. International, governmental and non-governmental organizations liaising with the IEC also participate in this preparation. IEC collaborates closely with the International Organization for Standardization (ISO) in accordance with conditions determined by agreement between the two organizations.
- 2) The formal decisions or agreements of IEC on technical matters express, as nearly as possible, an international consensus of opinion on the relevant subjects since each technical committee has representation from all interested IEC National Committees.
- 3) IEC Publications have the form of recommendations for international use and are accepted by IEC National Committees in that sense. While all reasonable efforts are made to ensure that the technical content of IEC Publications is accurate, IEC cannot be held responsible for the way in which they are used or for any misinterpretation by any end user.
- 4) In order to promote international uniformity, IEC National Committees undertake to apply IEC Publications transparently to the maximum extent possible in their national and regional publications. Any divergence between any IEC Publication and the corresponding national or regional publication shall be clearly indicated in the latter.
- 5) IEC itself does not provide any attestation of conformity. Independent certification bodies provide conformity assessment services and, in some areas, access to IEC marks of conformity. IEC is not responsible for any services carried out by independent certification bodies.
- 6) All users should ensure that they have the latest edition of this publication.
- 7) No liability shall attach to IEC or its directors, employees, servants or agents including individual experts and members of its technical committees and IEC National Committees for any personal injury, property damage or other damage of any nature whatsoever, whether direct or indirect, or for costs (including legal fees) and expenses arising out of the publication, use of, or reliance upon, this IEC Publication or any other IEC Publications.
- 8) Attention is drawn to the Normative references cited in this publication. Use of the referenced publications is indispensable for the correct application of this publication.
- 9) Attention is drawn to the possibility that some of the elements of this IEC Publication may be the subject of patent rights. IEC shall not be held responsible for identifying any or all such patent rights.

International Standard IEC 62899-201-2 has been prepared by IEC technical committee 119: Printed Electronics.

This International Standard is to be used in conjunction with IEC 62899-201:2016.

The text of this International Standard is based on the following documents:

Draft	Report on voting
119/369/FDIS	119/375/RVD

Full information on the voting for its approval can be found in the report on voting indicated in the above table.

The language used for the development of this International Standard is English.

This document was drafted in accordance with ISO/IEC Directives, Part 2, and developed in accordance with ISO/IEC Directives, Part 1 and ISO/IEC Directives, IEC Supplement, available at www.iec.ch/members_experts/refdocs. The main document types developed by IEC are described in greater detail at www.iec.ch/standardsdev/publications.

A list of all parts in the IEC 62899 series, published under the general title *Printed electronics*, can be found on the IEC website.

The committee has decided that the contents of this document will remain unchanged until the stability date indicated on the IEC website under webstore.iec.ch in the data related to the specific document. At this date, the document will be

- reconfirmed,
- withdrawn,
- replaced by a revised edition, or
- amended.

IMPORTANT – The 'colour inside' logo on the cover page of this publication indicates that it contains colours which are considered to be useful for the correct understanding of its contents. Users should therefore print this document using a colour printer.

INTRODUCTION

The IEC 62899-20x series relates mainly to measurement methods for materials of printed electronics. The series also includes storage methods, packaging and marking, and transportation conditions.

The IEC 62899-20x series is divided into parts for each material. Each part is prepared as a generic specification containing fundamental information for the area of printed electronics.

The IEC 62899-20x series consists of the following parts:

Part 201: Materials – Substrates

Part 201-2: Materials – Substrates – Measurement methods for properties of stretchable substrates

Part 202: Materials – Conductive ink

Part 202-3: Materials – Conductive ink – Measurement of sheet resistance of conductive films – Contactless method

Part 202-4: Materials – Conductive ink – Measurement methods for properties of stretchable printed layers (conductive and insulating)

Part 202-5: Materials – Conductive ink – Mechanical bending test of a printed conductive layer on an insulating substrate

Part 202-6: Materials – Conductive ink – Measurement method for resistance changes under high temperature and humidity – Printed conductive layer on a flexible substrate

Part 202-7: Materials – Printed film – Measurement of peel strength for printed layer on flexible substrate by the 90° peel method

Part 203: Materials – Semiconductor ink

Part 204: Materials – Insulator ink – Measurement methods of properties of insulator inks and printed insulating layers

(Subsequent parts will be prepared for other materials.)

Furthermore, each part will also include sectional specifications, blank detail specifications, and detail specifications of each material.

This part of IEC 62899 does not define the required characteristics of the stretchable substrate. It provides test methods to characterize (pre-qualify) the substrates that are intended to be used for printing conductors and insulators for the purposes of manufacturing stretchable layers or structures.

PRINTED ELECTRONICS -

Part 201-2: Materials – Substrates – Measurement methods for properties of stretchable substrates

1 Scope

This part of IEC 62899 defines measurement methods for the properties of stretchable substrates, in order to use evaluating stretchable functional layers (conductive, semiconducting, and insulating) formed by printing technologies. If the same types of materials as the substrates are used for the cover lay film, they are also subjected to the measurement defined in this document.

Stretchable substrates handled by this document apply to substrates subjected to repeated bending with wiring elements demanding a high level of performance, such as fabric integrated wearable devices or skin patchable devices.

2 Normative references

The following documents are referred to in the text in such a way that some or all of their content constitutes requirements of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

IEC 60243-1, *Electric strength of insulating materials – Test methods – Part 1: Tests at power frequencies*

IEC 62631-3-1, Dielectric and resistive properties of solid insulating materials – Part 3-1: Determination of resistive properties (DC methods) – Volume resistance and volume resistivity – General method

IEC 62631-3-2, Dielectric and resistive properties of solid insulating materials – Part 3-2: Determination of resistive properties (DC methods) – Surface resistance and surface resistivity

IEC 62899-201, Printed electronics – Materials – Part 201: Substrates

ISO 3801, Textiles – Woven fabrics – Determination of mass per unit length and mass per unit area

ISO 5084, Textiles – Determination of thickness of textiles and textile products

ISO 13934-1, Textiles – Tensile properties of fabrics – Part 1: Determination of maximum force and elongation at maximum force using the strip method

ISO 22198, Textiles – Fabrics – Determination of width and length